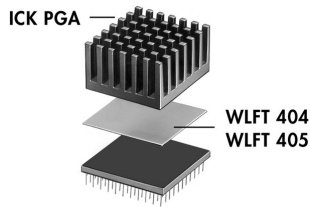


Data sheet Product ICK PGA 14 x 14 x 12

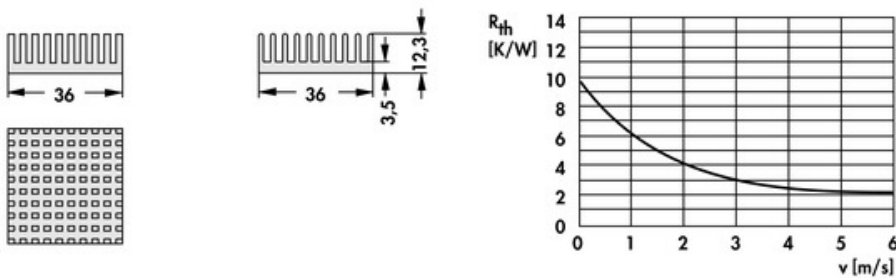


Heatsinks and active heatsinks for processors>Heatsinks for PGA
36 x 36 x 12.3 mm, for IC design PGA and others

Features

way of fixation:	<ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive
socket:	universal
suitable for processor type:	universal
width:	36 mm
height:	12.3 mm
plate thickness:	3.5 mm
length:	36 mm
thermal resistance:	9.8 - 2.1 K/W
dissipation loss:	5.3 W
surface:	black anodised

Technical Drawing



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